

SS54 THRU SS520
SCHOTTKY BARRIER RECTIFIERS



VOLTAGE: 40~200 Volts	CURRENT: 5.0 Amperes	DO-214AA(SMB)	Marking and Polarity
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FEATURES

- Low Forward Voltage Drop for high efficiency
- Low leakage current for high reliability
- High forward surge capability for high reliability

MECHANICAL DATA

- Terminals:** Plated Leads Solderable per MIL-STD-202, Method 208
- Mounting Position:** Any
- Lead Free:** Lead Free Finish, RoHS Compliant
- Weight:** App. 0.095 grams (0.0034 ounce)

TYPICAL APPLICATIONS

- For use in high frequency inverters , DC/DC converters, LED driver etc. applications

Remark:

- NH=niuhang trademark
- FF=Product line, According to actual changes;
YWW=Periodic code, According to actual changes;
- SS5xx=Modle, xxx=4,45,6,8,10,15,20
- White band denotes cathode

Maximum Ratings(Ratings at 25°C ambient temperature unless otherwise specified)

Parameter	Symbol	SS54	SS545	SS56	SS58	SS510	SS515	SS520	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	40	45	60	80	100	150	200	V
Maximum RMS voltage	V_{RMS}	28	32	42	56	70	105	140	V
Maximum DC blocking voltage	V_{DC}	40	45	60	80	100	150	200	V
Maximum average forward rectified current(see fig.1)	$I_{F(AV)}$	5.0							A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC method at rated TL)	I_{FSM}	120							A
Current Squared Time Per Diode(t<8.3ms)	I^2t	59.76							A ² sec

Electrical Characteristics (Ratings at 25°C ambient temperature unless otherwise specified)

Parameter	Test Conditions		Symbol	SS54	SS545	SS56	SS58	SS510	SS515	SS520	Unit
Maximum Forward Voltage(Note 1)	Ta=25°C	IF= 5.0 A	V_F	0.55	0.70	0.80	0.90				V
Maximum instantaneous reversecurrent at rated DC blockingvoltage (Note 1)	Ta=25°C	VR= V_{RRM}	I_{RRM}	100	80	50	10				uA
	Ta=125°C	VR= 80%* V_{RRM}		10	8	5	3				mA
Typical junction capacitance	4V, 1MHz		C_J	250	200	150	100				pF

Thermal Characteristics (Ratings at 25°C ambient temperature unless otherwise specified)

Parameter	Symbol	SS54	SS545	SS56	SS58	SS510	SS515	SS520	Unit	
Operating junction and Storage temperature range	T_J	-55 to 125			-55 to 150		-55 to 175			°C
Storage temperature range	T_{STG}	-55 to 125			-55 to 150		-55 to 175			
Typical thermal resistance (Note 2)	$R_{\theta JA}$	60								°C/W
	$R_{\theta JC}$	20								

Note: 1. Pulse width < 300 uS, Duty cycle < 2%
2. Mounted on P.C.B. with 0.3" x 0.3" (7.62 mm x 7.62 mm) copper pad areas

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RATING AND CHARACTERISTIC CURVES

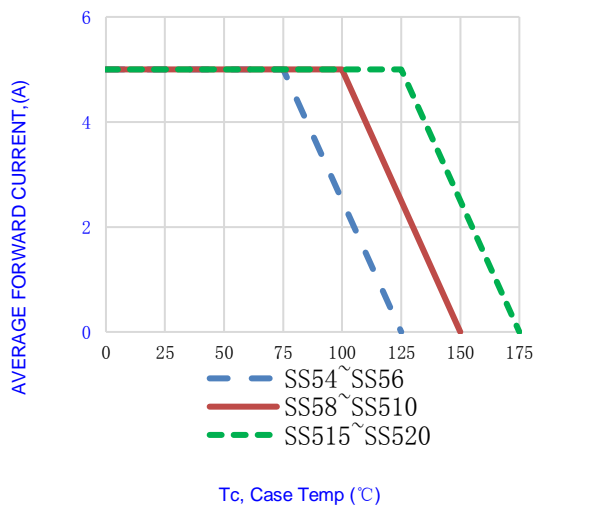


Fig.1-FORWARD CURRENT DERATING CURVE

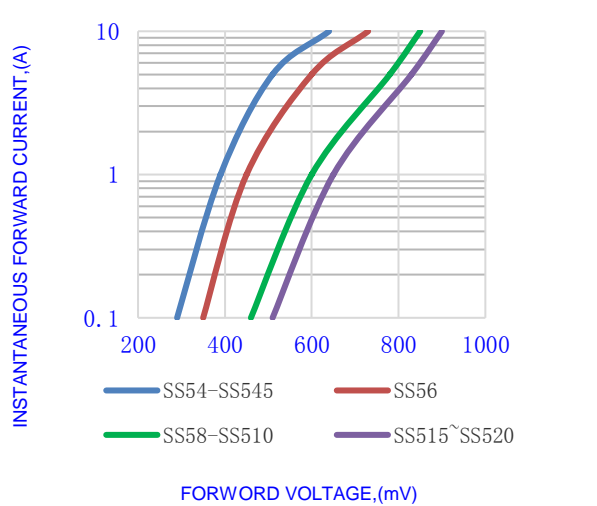


Fig.2- TYPICAL INSTANTANEOUS FORWARD

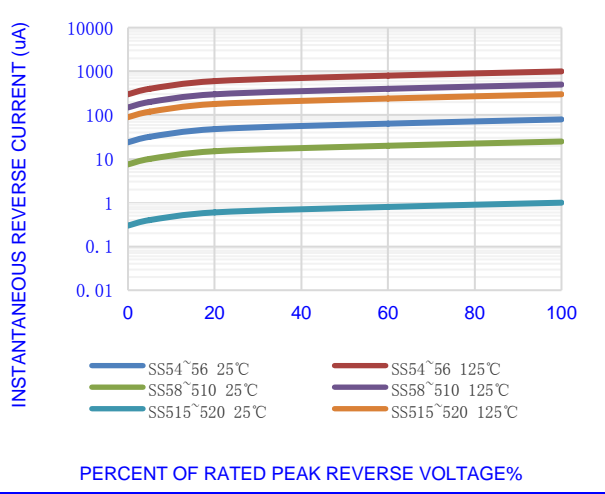


Fig.3- TYPICAL REVERSE CHARACTERISTICS

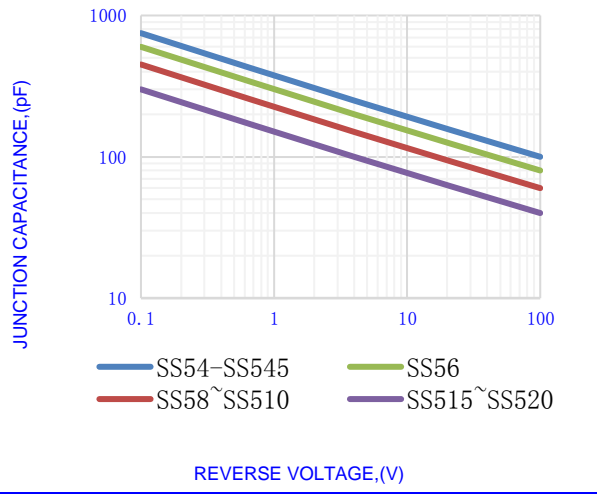


Fig.4-TYPICAL JUNCTION CAPACITANCE

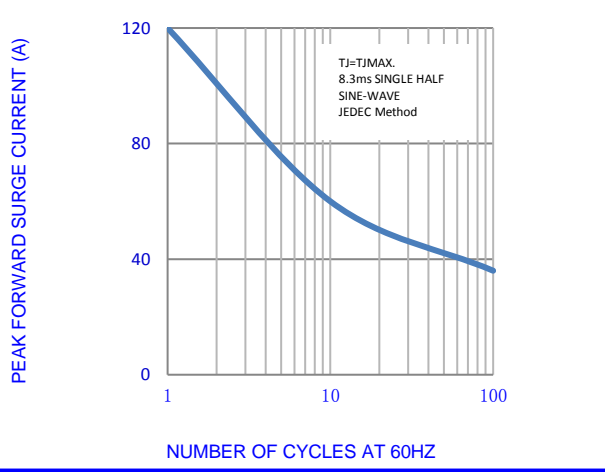


Fig.5-MAX. NON-REPETITIVE SURGE CURRENT

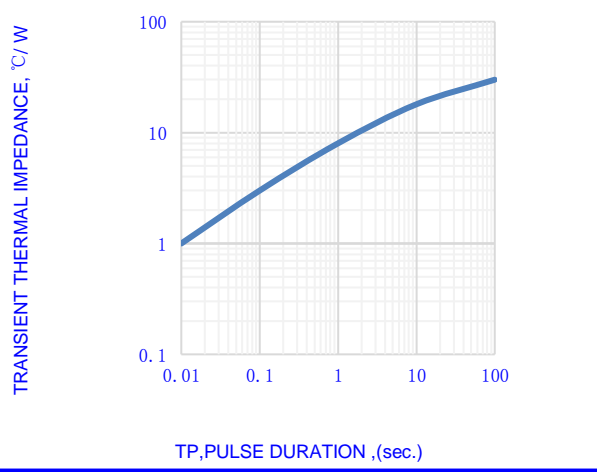


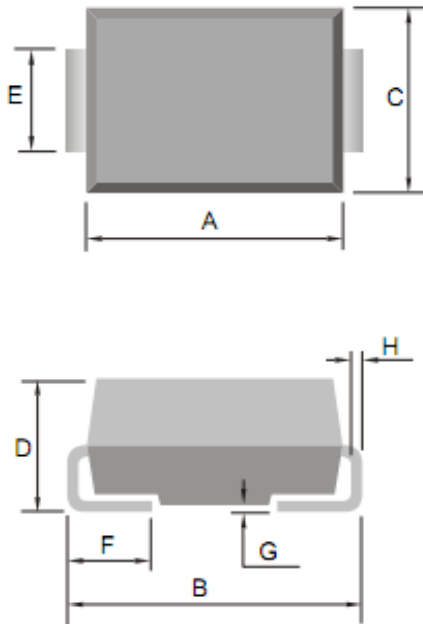
FIG.6-TYPICAL TRANSIENT THERMAL IMPEDANCE

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OUTLINE DRAWINGS

DO-214AA(SMB)

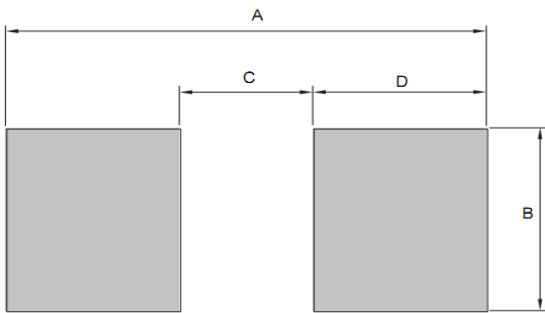


OUTLINE DIMENSIONS

DIM	MILLIMETERS			INCHES		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.060	-	4.700	0.160	-	0.185
B	5.080	-	5.590	0.200	-	0.220
C	3.300	-	3.940	0.130	-	0.155
D	2.130	-	2.440	0.083	-	0.096
E	1.910	-	2.110	0.075	-	0.083
F	0.760	-	1.270	0.030	-	0.050
G	0.051	-	0.203	0.002	-	0.008
H	0.152	-	0.305	0.006	-	0.012

RECOMMENDED LAYOUT DRAWINGS

DO-214AA(SMB)



RECOMMENDED MOUNTING PAD DIMENSIONS

Dim.	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	-	6.340	-	-	0.250	-
B	-	2.720	-	-	0.107	-
C	-	1.760	-	-	0.069	-
D	-	2.290	-	-	0.090	-

PACKING INFORMATION

DO-214AA(SMB)

Package Method	Reel Size (mm)	Quantity (pcs/reel)	Inner Box Size LxWxH(mm)	Quantity (pcs/Inner Box)	Carton Size LxWxH(mm)	Quantity (pcs/carton)
Tape Reel	Φ330	3000	340x340x45	6000	360x360x470	60000

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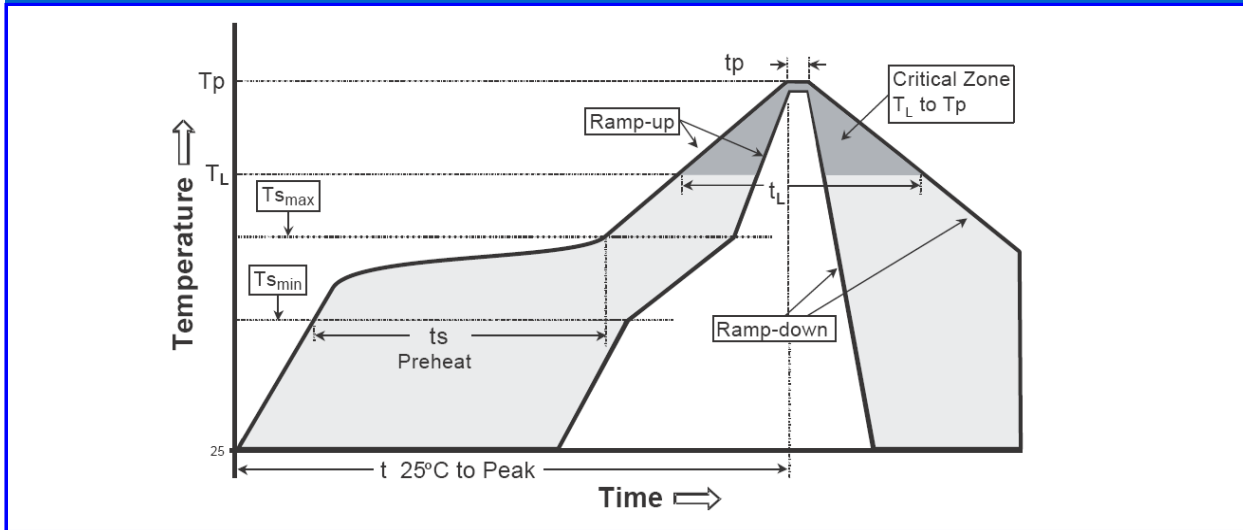
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Recommended wave soldering condition

Product	Peak Temperature	Soldering Time
Pb-free devices	260 +0/-5 °C	5 +1/-1 seconds

Recommended temperature profile for IR reflow



Profile feature	Sn-Pb eutectic Assembly	Pb-free Assembly
Average ramp-up rate (T _{smax} to T _p)	3°C/second max.	3°C/second max.
Preheat -Temperature Min(T _{s min}) -Temperature Max(T _{s max}) -Time(t _{s min} to t _{s max})	100°C 150°C 60-120 seconds	150°C 200°C 60-180 seconds
Time maintained above: -Temperature (T _L) - Time (t _L)	183°C 60-150 seconds	217°C 60-150 seconds
Peak Temperature(T _P)	240 +0/-5 °C	260 +0/-5 °C
Time within 5°C of actual peak temperature(t _p)	10-30 seconds	20-40 seconds
Ramp down rate	6°C/second max.	6°C/second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

Note : All temperatures refer to topside of the package, measured on the package body surface.

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